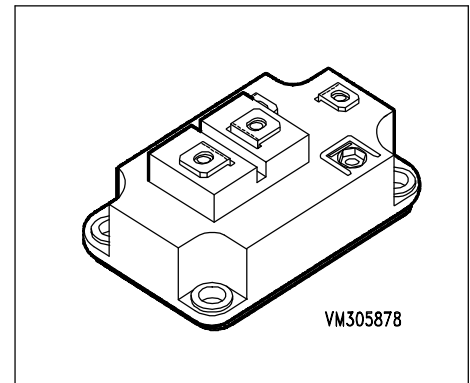


**IGBT Power Module**

- Single switch
- Including fast free-wheeling diodes
- Package with insulated metal base plate



| Type                 | $V_{CE}$ | $I_C$ | Package       | Ordering Code    |
|----------------------|----------|-------|---------------|------------------|
| BSM 400 GA 120 DN2   | 1200V    | 550A  | SINGLE SWITCH | C67070-A2302-A70 |
| BSM 400 GA 120 DN2 S | 1200V    | 550A  | SSW SENSE 1   | C67070-A2308-A70 |

**Maximum Ratings**

| Parameter                                      | Symbol      | Values        | Unit             |
|------------------------------------------------|-------------|---------------|------------------|
| Collector-emitter voltage                      | $V_{CE}$    | 1200          | V                |
| Collector-gate voltage                         | $V_{CGR}$   | 1200          |                  |
| $R_{GE} = 20 \text{ k}\Omega$                  |             |               |                  |
| Gate-emitter voltage                           | $V_{GE}$    | $\pm 20$      | A                |
| DC collector current                           | $I_C$       | 550           |                  |
| $T_C = 25 \text{ }^\circ\text{C}$              |             | 400           |                  |
| $T_C = 80 \text{ }^\circ\text{C}$              |             |               |                  |
| Pulsed collector current, $t_p = 1 \text{ ms}$ | $I_{Cpuls}$ | 1100          | W                |
| $T_C = 25 \text{ }^\circ\text{C}$              |             | 800           |                  |
| $T_C = 125 \text{ }^\circ\text{C}$             |             |               |                  |
| Power dissipation per IGBT                     | $P_{tot}$   | 2700          | $^\circ\text{C}$ |
| $T_C = 25 \text{ }^\circ\text{C}$              |             |               |                  |
| Chip temperature                               | $T_j$       | + 150         |                  |
| Storage temperature                            | $T_{stg}$   | -40 ... + 125 |                  |
| Thermal resistance, chip case                  | $R_{thJC}$  | $\leq 0.045$  | K/W              |
| Diode thermal resistance, chip case            | $R_{thJCD}$ | $\leq 0.09$   |                  |
| Insulation test voltage, $t = 1 \text{ min.}$  | $V_{is}$    | 2500          | Vac              |
| Creepage distance                              | -           | 20            | mm               |
| Clearance                                      | -           | 11            |                  |
| DIN humidity category, DIN 40 040              | -           | F             | sec              |
| IEC climatic category, DIN IEC 68-1            | -           | 40 / 125 / 56 |                  |

**Electrical Characteristics**, at  $T_j = 25\text{ °C}$ , unless otherwise specified

| Parameter | Symbol | Values |      |      | Unit |
|-----------|--------|--------|------|------|------|
|           |        | min.   | typ. | max. |      |

**Static Characteristics**

|                                                                                                                                                                                |               |        |            |          |    |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------|--------|------------|----------|----|
| Gate threshold voltage<br>$V_{GE} = V_{CE}, I_C = 16\text{ mA}$                                                                                                                | $V_{GE(th)}$  | 4.5    | 5.5        | 6.5      | V  |
| Collector-emitter saturation voltage<br>$V_{GE} = 15\text{ V}, I_C = 400\text{ A}, T_j = 25\text{ °C}$<br>$V_{GE} = 15\text{ V}, I_C = 400\text{ A}, T_j = 125\text{ °C}$      | $V_{CE(sat)}$ | -<br>- | 2.5<br>3.1 | 3<br>3.7 |    |
| Zero gate voltage collector current<br>$V_{CE} = 1200\text{ V}, V_{GE} = 0\text{ V}, T_j = 25\text{ °C}$<br>$V_{CE} = 1200\text{ V}, V_{GE} = 0\text{ V}, T_j = 125\text{ °C}$ | $I_{CES}$     | -<br>- | 6<br>24    | 8<br>-   | mA |
| Gate-emitter leakage current<br>$V_{GE} = 20\text{ V}, V_{CE} = 0\text{ V}$                                                                                                    | $I_{GES}$     | -      | -          | 400      |    |

**AC Characteristics**

|                                                                                               |           |     |    |   |    |
|-----------------------------------------------------------------------------------------------|-----------|-----|----|---|----|
| Transconductance<br>$V_{CE} = 20\text{ V}, I_C = 400\text{ A}$                                | $g_{fs}$  | 216 | -  | - | S  |
| Input capacitance<br>$V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 1\text{ MHz}$            | $C_{iss}$ | -   | 26 | - | nF |
| Output capacitance<br>$V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 1\text{ MHz}$           | $C_{oss}$ | -   | 4  | - |    |
| Reverse transfer capacitance<br>$V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 1\text{ MHz}$ | $C_{rss}$ | -   | 2  | - |    |

**Electrical Characteristics**, at  $T_j = 25\text{ °C}$ , unless otherwise specified

| Parameter | Symbol | Values |      |      | Unit |
|-----------|--------|--------|------|------|------|
|           |        | min.   | typ. | max. |      |

**Switching Characteristics, Inductive Load at  $T_j = 125\text{ °C}$** 

|                                                                                                                                   |              |   |     |     |    |
|-----------------------------------------------------------------------------------------------------------------------------------|--------------|---|-----|-----|----|
| Turn-on delay time<br>$V_{CC} = 600\text{ V}$ , $V_{GE} = 15\text{ V}$ , $I_C = 400\text{ A}$<br>$R_{Gon} = 2.7\text{ }\Omega$    | $t_{d(on)}$  | - | 100 | 200 | ns |
| Rise time<br>$V_{CC} = 600\text{ V}$ , $V_{GE} = 15\text{ V}$ , $I_C = 400\text{ A}$<br>$R_{Gon} = 2.7\text{ }\Omega$             | $t_r$        | - | 110 | 220 |    |
| Turn-off delay time<br>$V_{CC} = 600\text{ V}$ , $V_{GE} = -15\text{ V}$ , $I_C = 400\text{ A}$<br>$R_{Goff} = 2.7\text{ }\Omega$ | $t_{d(off)}$ | - | 550 | 800 |    |
| Fall time<br>$V_{CC} = 600\text{ V}$ , $V_{GE} = -15\text{ V}$ , $I_C = 400\text{ A}$<br>$R_{Goff} = 2.7\text{ }\Omega$           | $t_f$        | - | 80  | 120 |    |

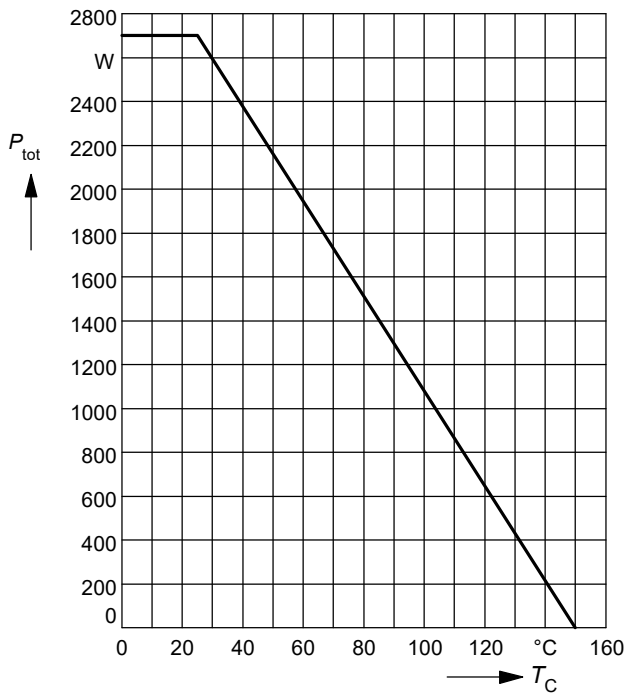
**Free-Wheel Diode**

|                                                                                                                                                                                            |          |   |            |          |               |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|---|------------|----------|---------------|
| Diode forward voltage<br>$I_F = 400\text{ A}$ , $V_{GE} = 0\text{ V}$ , $T_j = 25\text{ °C}$<br>$I_F = 400\text{ A}$ , $V_{GE} = 0\text{ V}$ , $T_j = 125\text{ °C}$                       | $V_F$    | - | 2.3<br>1.8 | 2.8<br>- | V             |
| Reverse recovery time<br>$I_F = 400\text{ A}$ , $V_R = -600\text{ V}$ , $V_{GE} = 0\text{ V}$<br>$di_F/dt = -3000\text{ A}/\mu\text{s}$ , $T_j = 125\text{ °C}$                            | $t_{rr}$ | - | 0.6        | -        |               |
| Reverse recovery charge<br>$I_F = 400\text{ A}$ , $V_R = -600\text{ V}$ , $V_{GE} = 0\text{ V}$<br>$di_F/dt = -3000\text{ A}/\mu\text{s}$<br>$T_j = 25\text{ °C}$<br>$T_j = 125\text{ °C}$ | $Q_{rr}$ | - | 16<br>45   | -<br>-   | $\mu\text{C}$ |
|                                                                                                                                                                                            |          | - |            |          |               |

**Power dissipation**

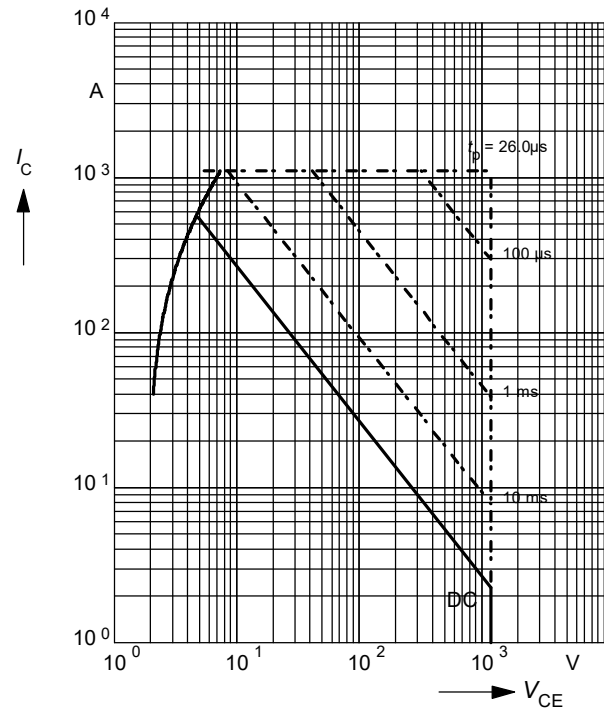
$$P_{\text{tot}} = f(T_C)$$

parameter:  $T_j \leq 150^\circ\text{C}$

**Safe operating area**

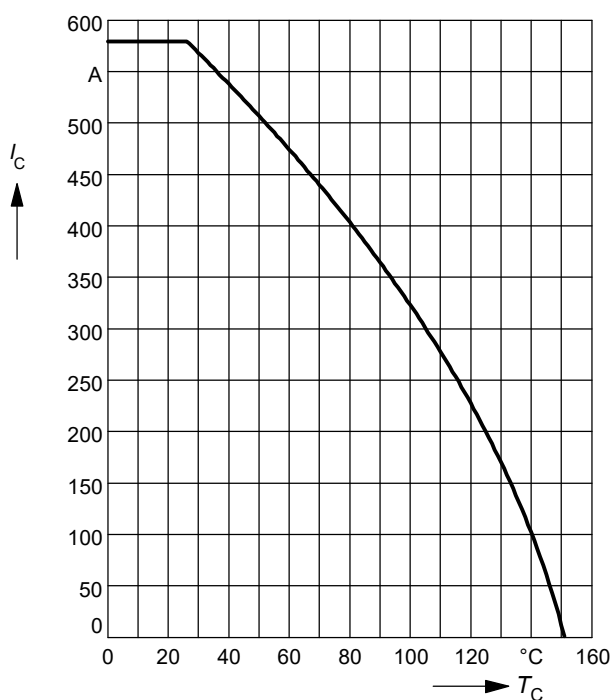
$$I_C = f(V_{CE})$$

parameter:  $D = 0$ ,  $T_C = 25^\circ\text{C}$ ,  $T_j \leq 150^\circ\text{C}$

**Collector current**

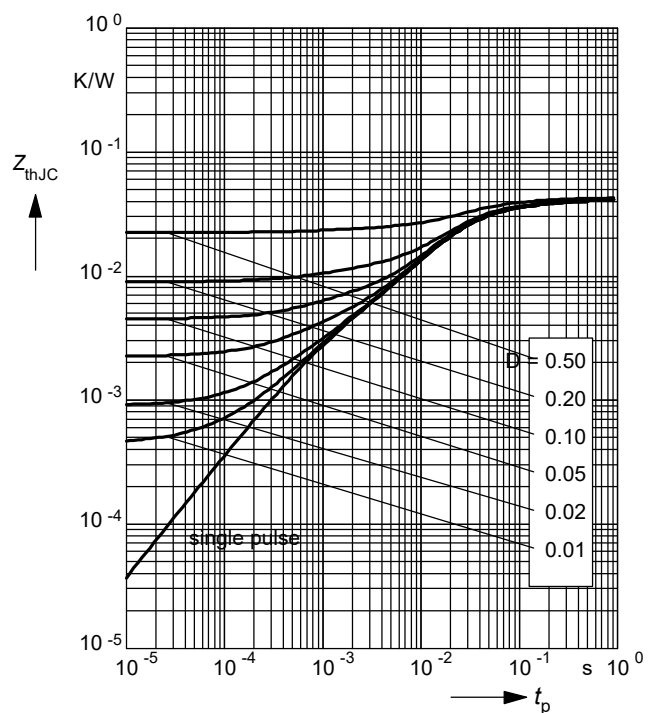
$$I_C = f(T_C)$$

parameter:  $V_{GE} \geq 15\text{ V}$ ,  $T_j \leq 150^\circ\text{C}$

**Transient thermal impedance IGBT**

$$Z_{\text{thJC}} = f(t_p)$$

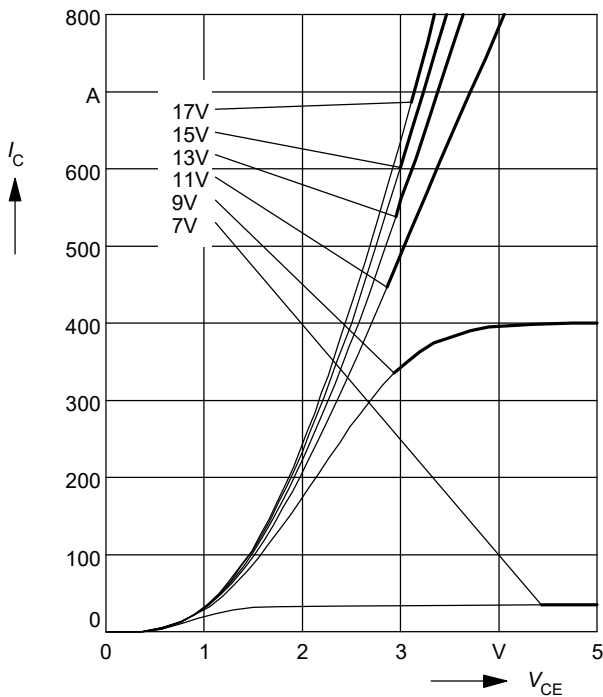
parameter:  $D = t_p / T$



**Typ. output characteristics**

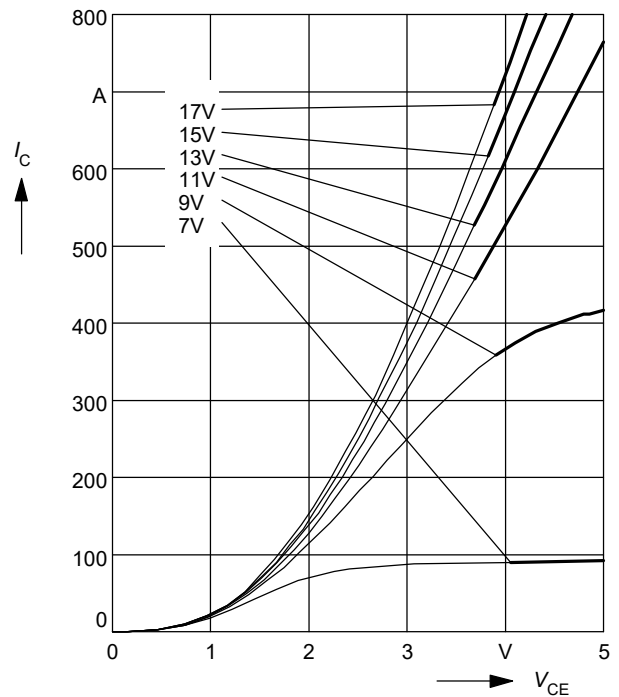
$$I_C = f(V_{CE})$$

parameter:  $t_p = 80 \mu s$ ,  $T_j = 25^\circ C$

**Typ. output characteristics**

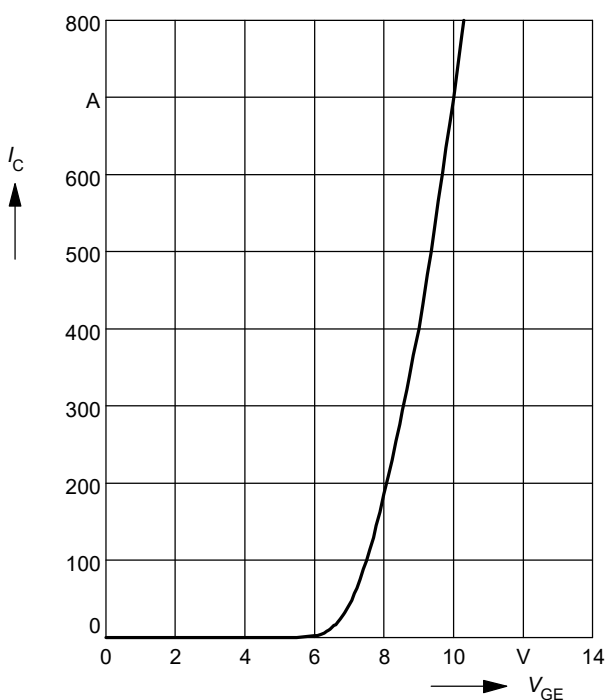
$$I_C = f(V_{CE})$$

parameter:  $t_p = 80 \mu s$ ,  $T_j = 125^\circ C$

**Typ. transfer characteristics**

$$I_C = f(V_{GE})$$

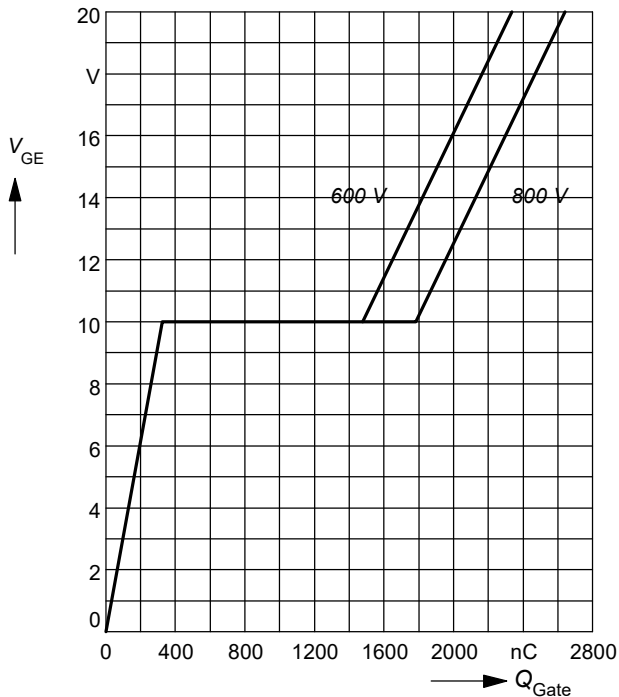
parameter:  $t_p = 80 \mu s$ ,  $V_{CE} = 20 V$



**Typ. gate charge**

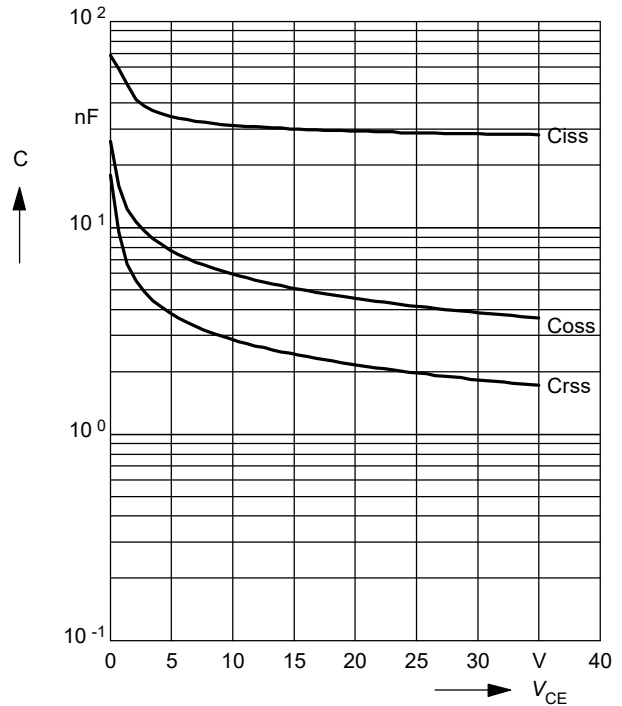
$$V_{GE} = f(Q_{Gate})$$

parameter:  $I_{C\ puls} = 400\ A$

**Typ. capacitances**

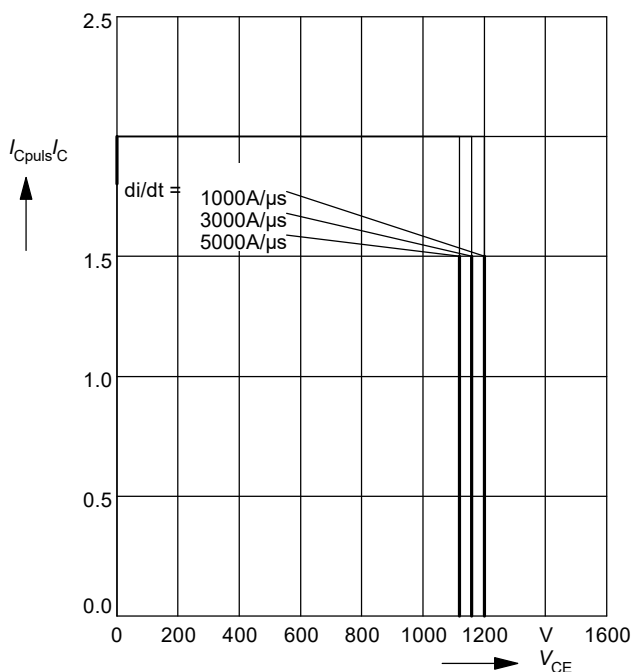
$$C = f(V_{CE})$$

parameter:  $V_{GE} = 0\ V$ ,  $f = 1\ MHz$

**Reverse biased safe operating area**

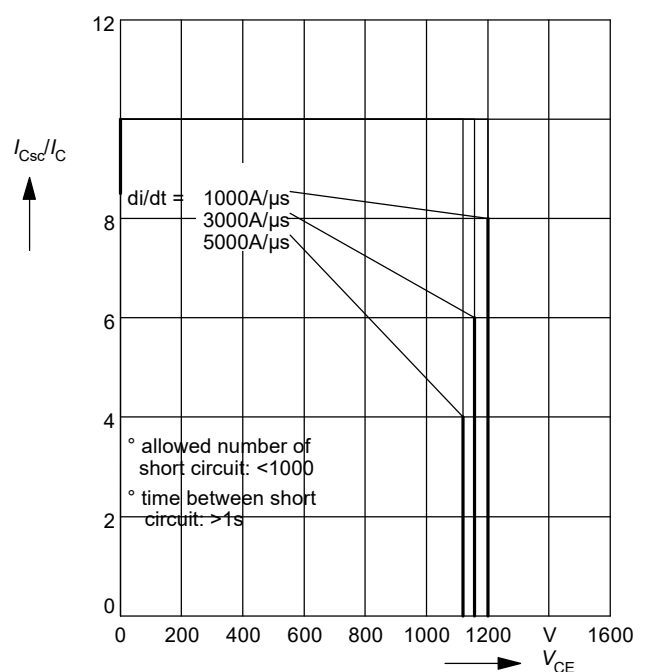
$$I_{C\ puls} = f(V_{CE}), T_j = 150^\circ C$$

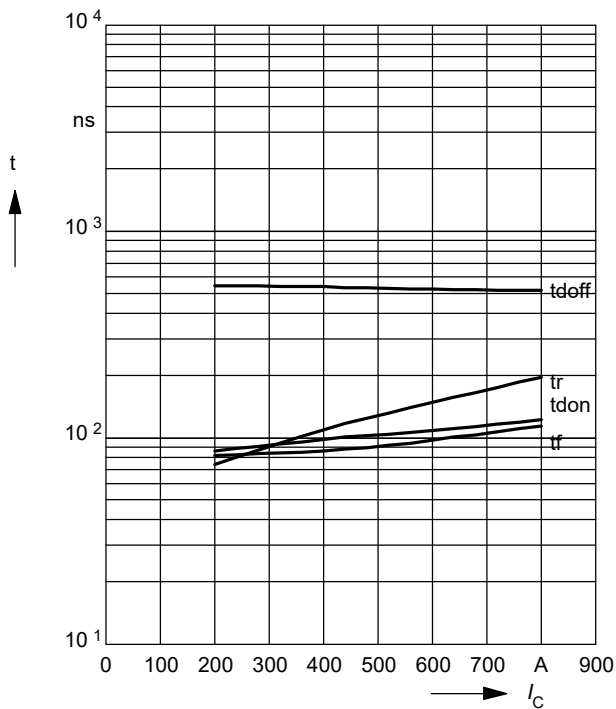
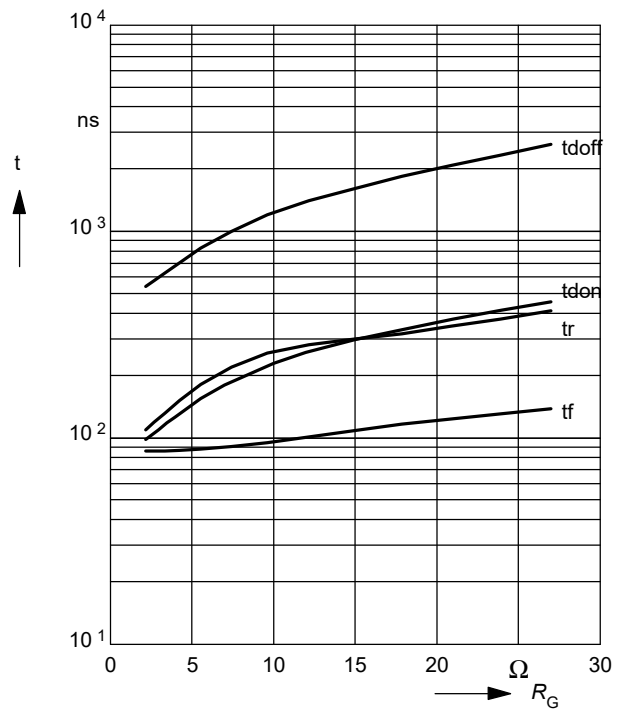
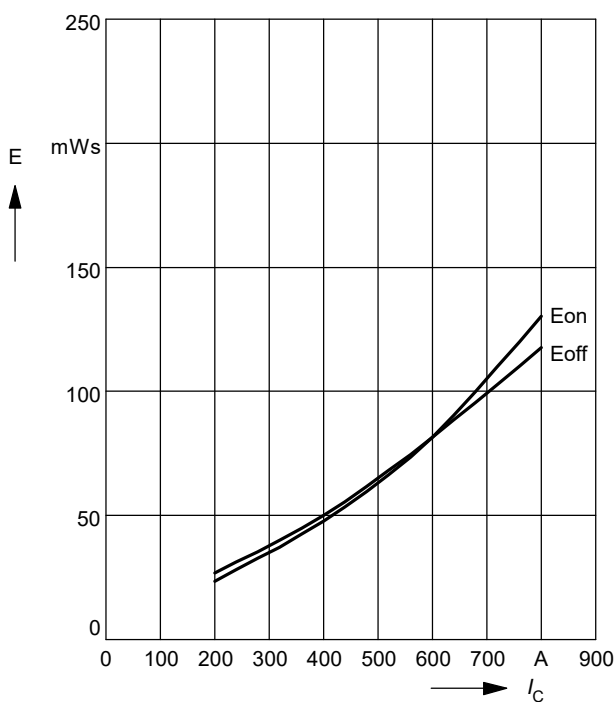
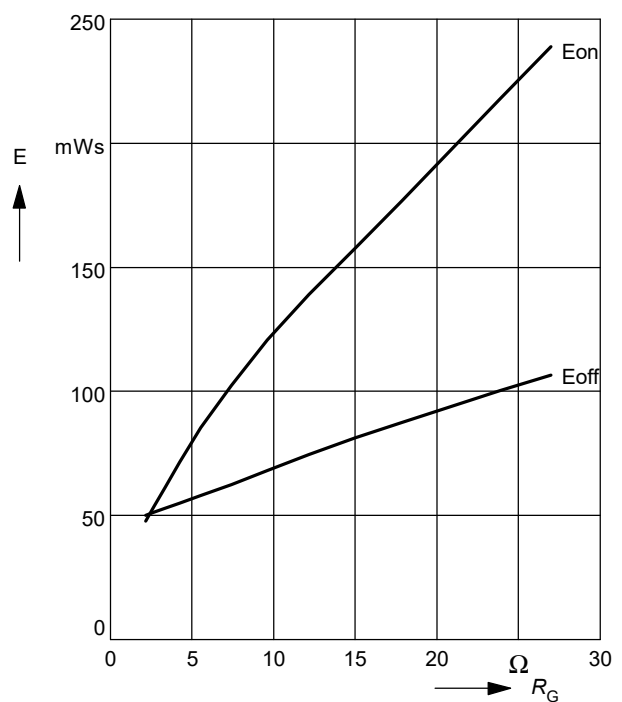
parameter:  $V_{GE} = \pm 15\ V$ ,  $t_p \leq 1\ ms$ ,  $L < 20\ nH$

**Short circuit safe operating area**

$$I_{C\ sc} = f(V_{CE}), T_j = 150^\circ C$$

parameter:  $V_{GE} = \pm 15\ V$ ,  $t_{SC} \leq 10\ \mu s$ ,  $L < 20\ nH$

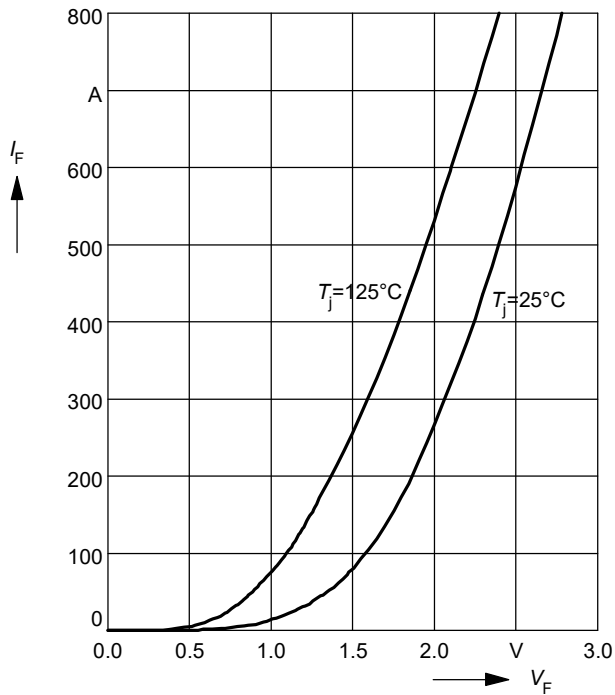


**Typ. switching time** $I = f(I_C)$ , inductive load,  $T_j = 125^\circ\text{C}$ par.:  $V_{CE} = 600\text{ V}$ ,  $V_{GE} = \pm 15\text{ V}$ ,  $R_G = 2.7\ \Omega$ **Typ. switching time** $t = f(R_G)$ , inductive load,  $T_j = 125^\circ\text{C}$ par.:  $V_{CE} = 600\text{ V}$ ,  $V_{GE} = \pm 15\text{ V}$ ,  $I_C = 400\text{ A}$ **Typ. switching losses** $E = f(I_C)$ , inductive load,  $T_j = 125^\circ\text{C}$ par.:  $V_{CE} = 600\text{ V}$ ,  $V_{GE} = \pm 15\text{ V}$ ,  $R_G = 2.7\ \Omega$ **Typ. switching losses** $E = f(R_G)$ , inductive load,  $T_j = 125^\circ\text{C}$ par.:  $V_{CE} = 600\text{ V}$ ,  $V_{GE} = \pm 15\text{ V}$ ,  $I_C = 400\text{ A}$ 

### Forward characteristics of fast recovery reverse diode

$I_F = f(V_F)$

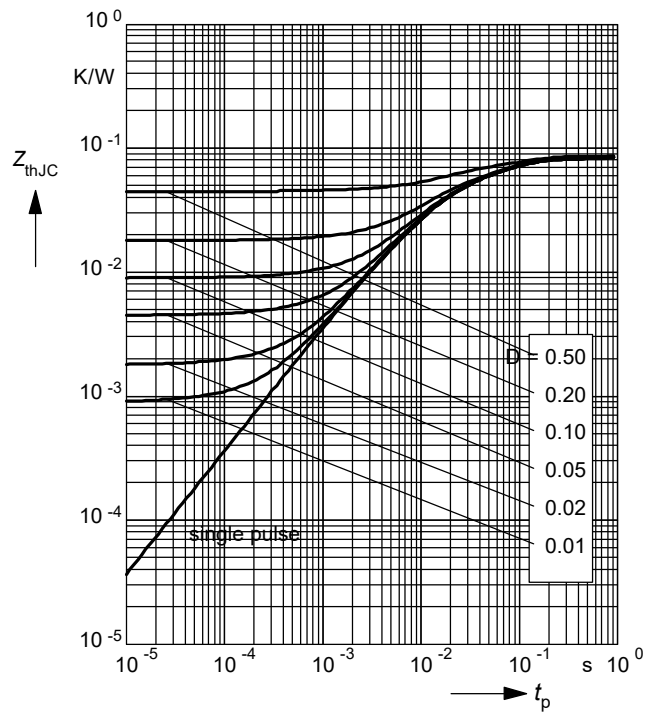
parameter:  $T_j$

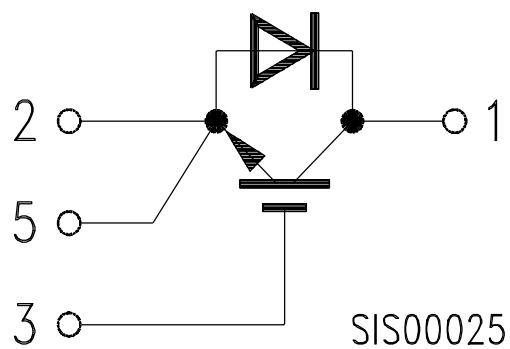


### Transient thermal impedance Diode

$Z_{thJC} = f(t_p)$

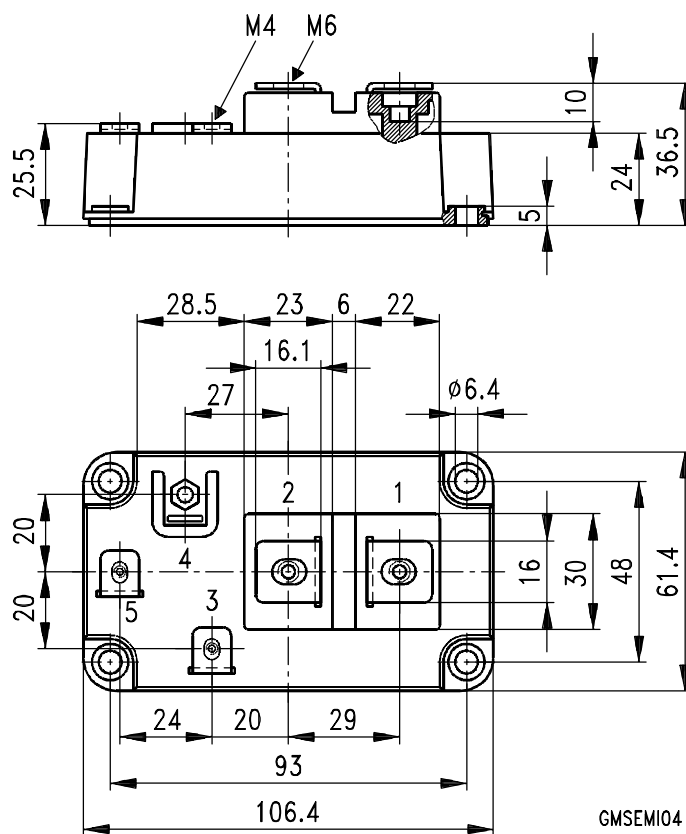
parameter:  $D = t_p / T$



**Circuit Diagram****Package Outlines**

Dimensions in mm

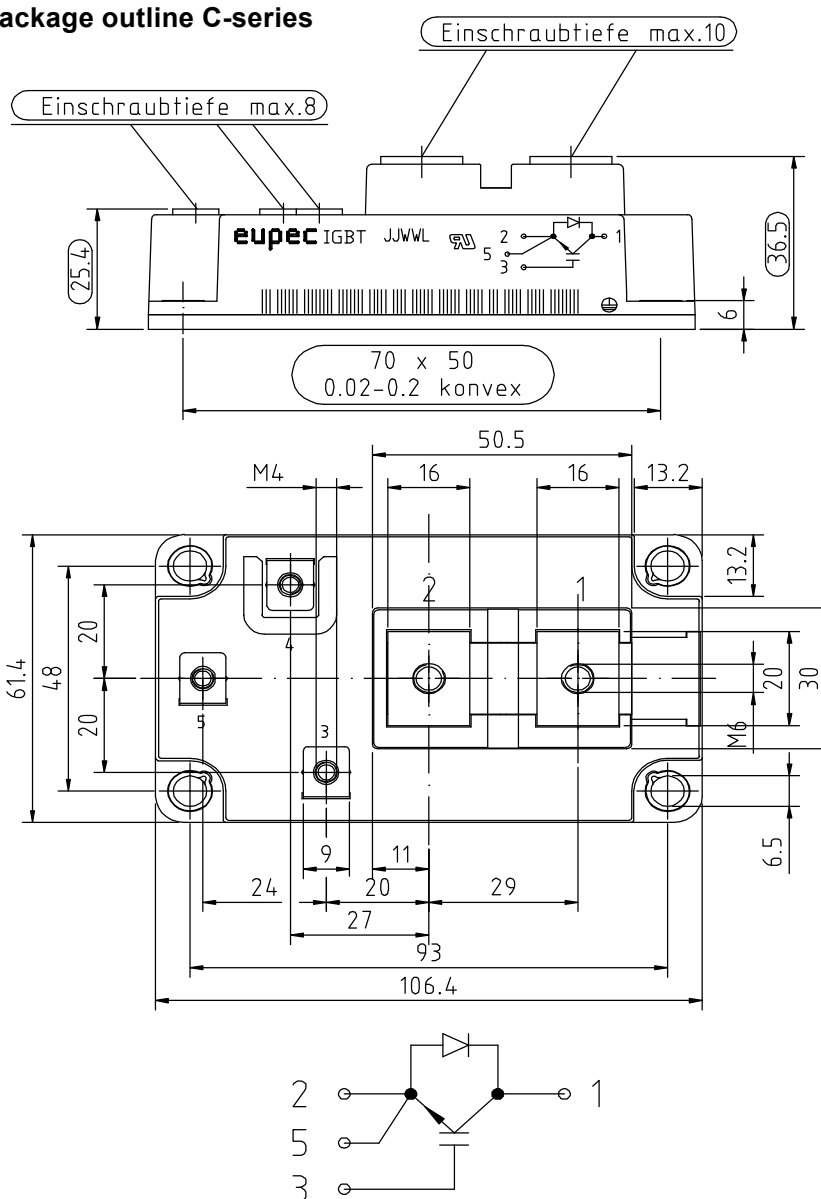
Weight: 420 g





typ.

|                                              |  |           |    |    |
|----------------------------------------------|--|-----------|----|----|
| Modulinduktivität<br>stray inductance module |  | $L_{sCE}$ | 20 | nH |
|----------------------------------------------|--|-----------|----|----|



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